

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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MI1206K310R-10

UNCONTROLLED DOCUMENT

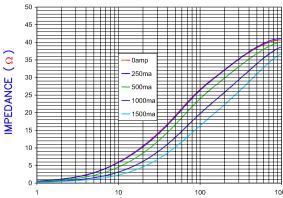
PHYSICAL DIMENSIONS:

A 3.20 [.126] ± 0.20 [.008] B 1.60 [.063] ± 0.20 [.008]

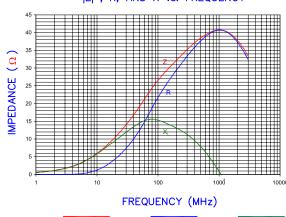
C 1.10 [.043] ± 0.20 [.008]

D 0.51 [.020] ± 0.25 [.010]

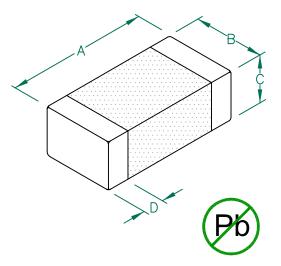
Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



FREQUENCY (MHz) |Z| , R, AND X vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3227

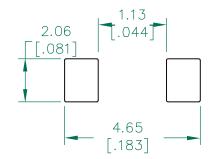


ELECT	ELECTRICAL CHARACTERISTICS:										
Z @ 100MHz (Ω)		DCR (Ω)	Rated Current								
Nominal	31										
Minimum	23										
Maximum	39	0.045	1500 mA								

NOTES: UNLESS OTHERWISE SPECIFIED

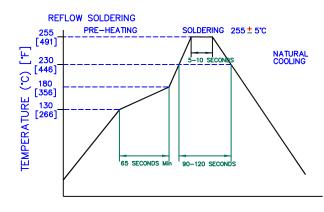
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS





DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird				
				Tech. and is loaned in confidence subject to return upon request and			-	
				with the understanding that no	Laird			
				copies shall be made without the written consent of Laird Tech. All				
				rights to design or invention are reserved.				
	ADD ODEDATING TEMPERATURE			1	REV	PART TY	PE:	DRAWN BY:
С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	MI1206K310R-10	С	co-	FIRE	JRK
В	UPDATE COMPANY LOGO ADD ROHS	8/22/08	JRK	DATE: 04 /4 7 /04 SCAL	E:		SHEET:	<u> </u>
Α	ORIGINAL DRAFT	04/13/04	JRK	DATE: 04/13/04 SCAL		TS		
			_	CAD #	- # T		2	of 2
REV	I DESCRIPTION	DATE	INT	MI1206K310R-10-C	_	_	_	01 2